# MICROCHIP

## **Total Ionizing Dose Characterization** of Microchip Programmable Current **Limiting Power Switch LX7712**

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**Abstract:** The total ionizing dose characterization results of the Microchip radiation hardened programmable current limiting power switch IC, the LX7712, are presented.

#### INTRODUCTION

#### A. Device Description

- The LX7712 is a programmable current limiting power switch.
- Contains a solid-state switch based on a P Channel MOSFET and a catch diode.
- Switches voltages up to 120 VDC and DC load with current up to 5A.
- Multiple devices can be paralleled in a master/slave arrangement to increase the current rating.
- Configurable as a latch-able current limiter or a fold-back current limiter.

#### 4. TID TESTING RESULTS: 100 krad (Si)

Parameter	Min	Тур	Max	Pre TID	Post 100krad	Units	Comments
<b>Operating Characteristics</b>							
Internal IC current consumption, switch ON	-20		0	-11.0 – -10.3	-10.7 – -9.8	mA	Stable
Internal Under Voltage Threshold	14.5	15	15.5	14.7 – 14.9	14.8 – 15.0	V	Stable
HS_RAIL voltage below line	9	10	11	9.91 – 9.97	9.87 – 9.94	V	Stable
LS_RAIL voltage above ground	9	10	11	10.48-10.53	10.43 – 10.50	V	Stable
Reference voltage VREF	4.9	5	5.1	4.93-4.99	4.93 – 4.99	V	Stable
Reference voltage VREF Current Limit	-2	-9	-15	-8.98.5	-8.98.2	mA	Stable
Switch Characteristics							
Switch Voltage drop	0	150	210	112 – 127	131 – 167	mV	Increase ~20%
Switch off leakage	0		55	11.2 – 12.8	12.7 – 14.1	uA	Stable
Switch turn-on time	0		450	329 – 369	380 – 520	us	Stable
Reverse Voltage at 5A	-1		0	-0.93 – -0.92	-0.950.90	V	Stable
Timer Characteristics							
Shutdown reaction time	0		50	33.0 – 37.1	28.2 – 33.3	us	Decrease ~5us
Timer threshold voltage rising	99	100	101	99.7 – 100.5	99.6 – 100.1	% of VREF	Stable
Timer threshold voltage falling	19	20	21	20.1 – 20.3	19.7 – 20.1	% of VREF	Stable
Timer discharged voltage	0		100	13 – 24	13 – 25	mV	Stable
Timer trip to SH_DN delay	0		5	3.7 – 4.5	3.9 – 4.5	us	Stable
Logic Inputs Characteristics							
Input logic high level	0.8		2.0	1.5 –1.6	1.6 – 1.7	V	Increase 0.1V
Input logic low level	0.8		2.0	1.3– 1.4	1.4 – 1.6	V	Increase 0.1V
Leakage Current ON, OFF, FB_LVL, HICCUP	0		10	1.0 – 5.0	1.0 – 5.0	uA	Stable
Leakage Current SHDN	-50		50	-1210	-1210	uA	Stable

- Manufactured as a single die solution in a 48-pin HTF ceramic package.
- The LX7712 includes voltage and temperature monitors for system safety:
- Line voltage monitor shuts off the switch immediately if the line drops below 10V.
- Thermal fault detector outputs on the OT\_FLT pin to alert die over-temperature and can be connected to the SHDN pin for thermal auto-shutdown.
- A secondary, user-programmable, under voltage lock-out (UVLO) that performs a soft shut-off by ramping the current down before shut-off.
- Load voltage monitoring comparator (VO\_MON) is also user-programmable by external resistors and causes an alert via the STATUS pin.

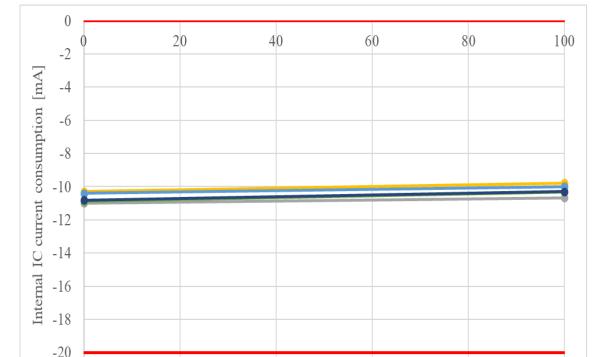
#### **B.** Part Rating and Classification

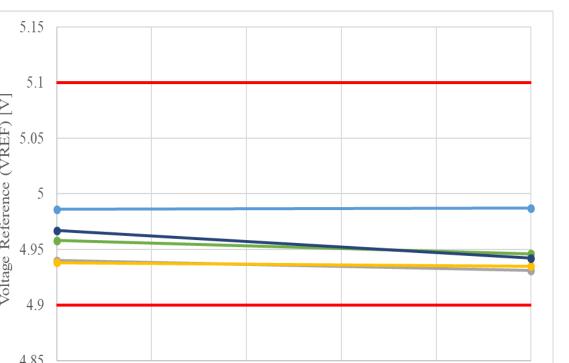
- Temperature range: -55 °C to 125 °C.
- Radiation rating goals:
- TID tolerance is greater than 100 krad (Si).
- ELDRS tolerance is greater than 50 krad (Si).
- SEL immune up to >80 MeV.cm<sup>2</sup>/mg and 125 °C.
- Qualification under MIL-PRF-38535 for QML-Q and QML-V.
- ESA Standards:
- ECSS-E-HB-20-20A.
- ECSS-E-ST-20-20C.
- Meets ESA LCL Classes 1, 2, 3, 4, 4A, 4B with 28V and 50V nominal bus voltages.
- Meets ESA RLCL Classes 0.5, 1, 1A, 1B, 2, 2A, 2B with 28V and 50V nominal bus voltages.
- The LX7712 is classified under EAR 9a515.e.

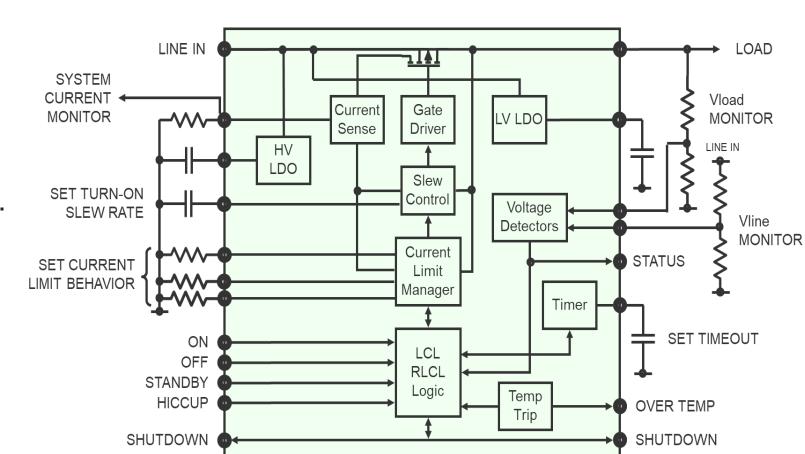
#### **C.** Modes of Operation

- Hard Current Limit:
- The LX7712 operates as either a latching current limiter (LCL) or a re-triggerable latching current limiter (RLCL).
- In latching mode, the power switch is turned off after a permanent (non-transient) fault is established and stays off until an external control system pulses the ON input.

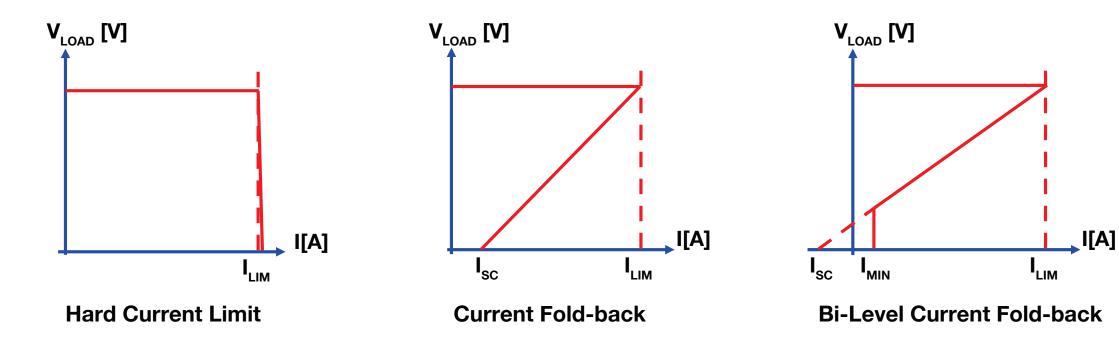
#### A. Operating Characteristics







- In re-triggerable latching mode, the power switch is turned off as for latching mode but will autonomously attempt to turn back on again repeatedly (hiccup mode), with a programmable delay between attempts.
- Current Fold-Back:
- Part folds back to the programmable safe minimum current  $(I_{sc})$  to allow auto restart on fault recovery.
- Bi-level current Fold-Back:
- Contains a soft short prevention provision that deters stable operation under high switch current with high switch voltage conditions. The current limit load line is purposely tilted so that a resistive overload will not settle at an intermediate level of fault current.
- Part folds back to the programmable minimum operating fold-back current  $(I_{MIN})$ .



#### 2. LX7712 – RADIATION TOLERANT BY DESIGN

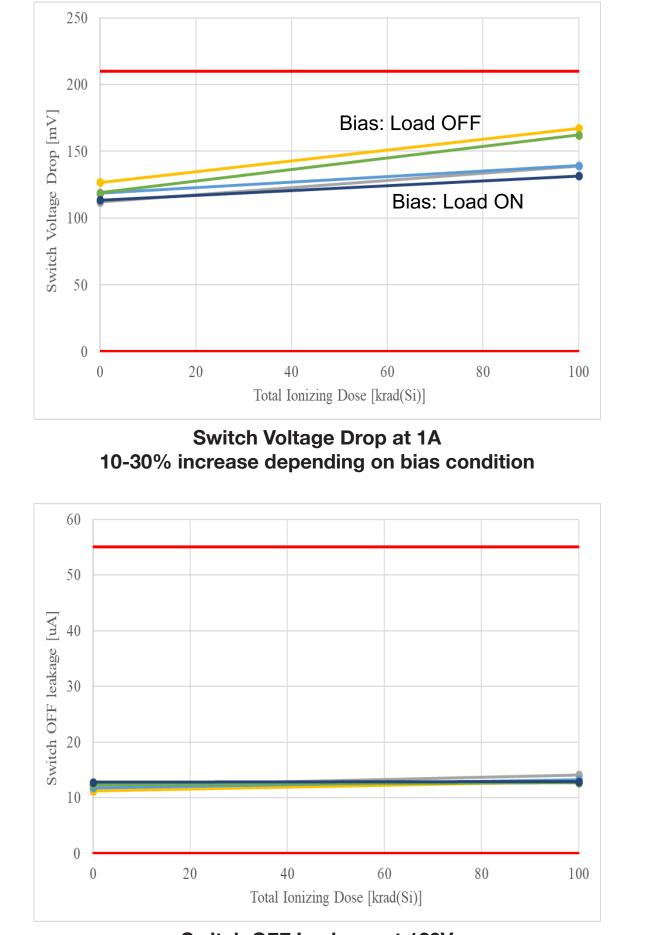
- The Microchip hardening solution involves a series of test chips and careful device characterization of the power MOSFET in order to optimize layout, voltage breakdown and switch resistance (RDSON) for maximum performance.
- The LX7712 is designed using a Dielectric Isolated technology process capable of high voltage operation up to 350V which is well beyond the absolute max rated operating voltage of the LX7712 of 150V.

### LX7712 TID TEST PLAN AND TEST SUMMARY

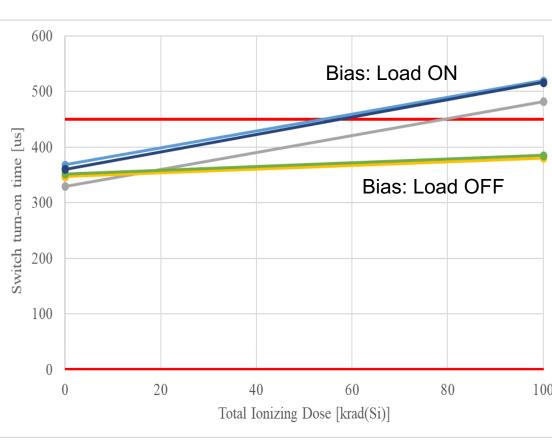
#### A. TID Test Plan



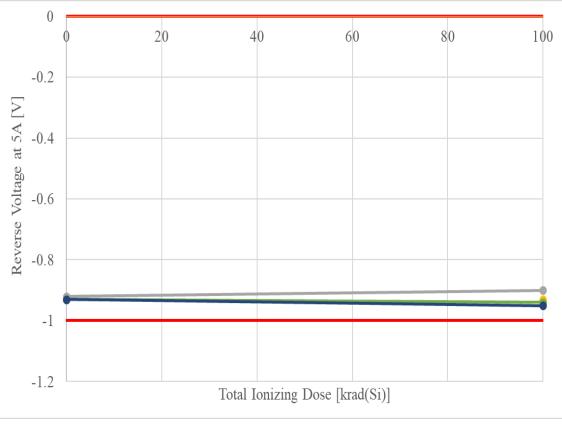
#### **B.** Switch Characteristics



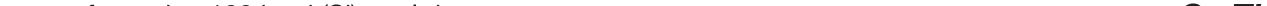
Switch OFF Leakage at 120V **Very Stable** 



Switch Turn-on Time at 1A 30-150 us increase depending on bias condition



Switch Reverse Voltage at 5A **Very Stable** 



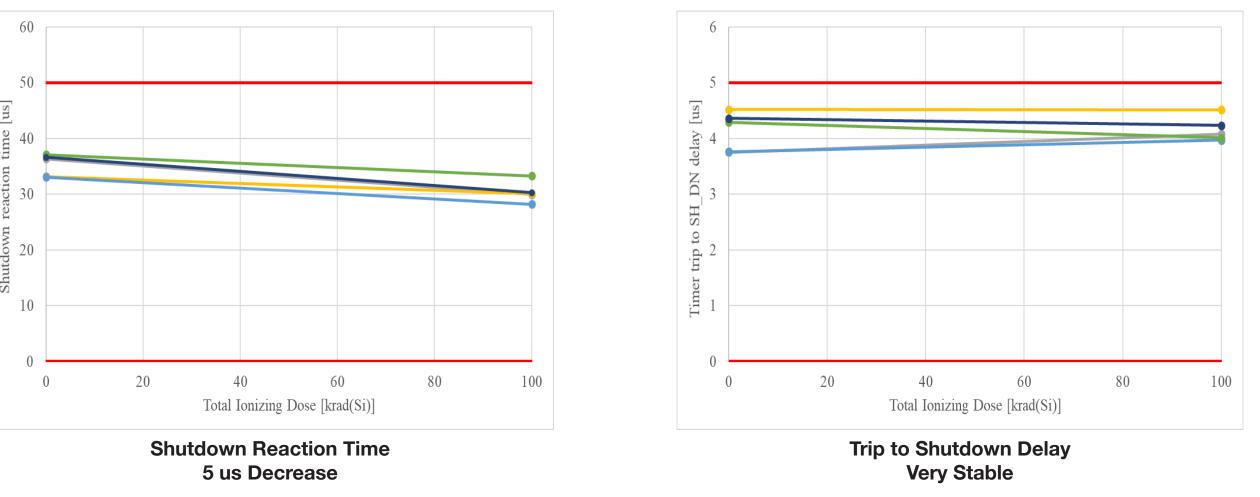
X7712-ES

- The LX7712 TID testing was performed at 100 krad (Si) total dose.
- The TID testing was completed at the Defense Microelectronics Activity (DMEA) test facility in McClellan, California, radiation source Co-60.
- The TID testing followed MIL-STD-883 test method 1019.9, condition A with a dose rate of 50 rad/s. The devices used were part of the first engineering samples.
- The devices were characterized pre-radiation and post-radiation using the ATE characterization test program. Two bias conditions were used during irradiation: output load ON and output load OFF.

#### B. 100 krad(Si) TID Test Summary

- The LX7712 performance after 100 krad(Si) exposure is overall very stable and comparable to pre-irradiation.
- Results show very good results on all key parameters of the part:
- Stable supply current consumptions. • Stable internally regulated voltages.
- Stable under-voltage detection thresholds. • Stable leakages.
- Increase 10% load ON and 30% load OFF of the switch voltage drop, still within pre-irradiation specification.
- Small decrease (~5 us) in shutdown reaction time.
- Results also exhibit an increase in turn-on time dependent on the bias condition during irradiation. The increase was 150 us if the load was on and 30 us if the load was kept off.
- This shift is not expected to pose any problem at system level as it is only a short additional delay to the nominal 350 us needed to turn on the load.
- Thus, we conclude that the performance of the LX7712 is TID tolerant up to 100 krad(Si).

#### **Timer Characteristics** С.



#### 5. CONCLUSION

The LX7712 performance after 100 krad(Si) TID under two biasing conditions is determined to be good and comparable to pre-irradiation. Only a few parameters exhibited some shifts. However, none of the shifts will impact the system-level performance.